

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: K. TOSHIYASU, et al.

Application No.: Rule 1.53(b) Divisional of U.S. Patent Application Serial
No. 10/111,231, filed April 23, 2002

Filed: On Even Date Herewith

For: ADHESIVE FILM FOR SEMICONDUCTOR, LEAD
FRAME AND SEMICONDUCTOR DEVICE USING THE
SAME, AND METHOD FOR MANUFACTURING
SEMICONDUCTOR DEVICE

Art Group of Parent: 2827

Examiner of Parent: D. A. Zarneke

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 15, 2003

Sir:

Please amend the above-identified application, prior to examination thereof,
as listed in the following, and as set forth on the following pages:

Amendment to the Specification; and

Remarks are included following the amendments.